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FCH072N60F_F085

N-Channel SuperFET II FRFET MOSFET

600 V, 52 A, 72 m Ω

Features

- Typical $R_{DS(on)}$ = 62 m Ω at V_{GS} = 10 V, I_D = 26 A
- Typical $Q_{g(tot)}$ = 160 nC at V_{GS} = 10V, I_D = 26 A
- UIS Capability
- Qualified to AEC Q101
- RoHS Compliant

Description

SuperFET® II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently SuperFETII is very well suited for the Soft switching and Hard Switching topologies like High Voltage Full Bridge and Half Bridge DC-DC, Interleaved Boost PFC, Boost PFC for HEV-EV automotive.

SuperFET II FRFET® MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.



For current package drawing, please refer to the Fairchild website at https://www.fairchildsemi.com/package-drawings/TO/ TO247A03.pdf

Application

- Automotive On Board Charger
- Automotive DC/DC converter for HEV



November 2014 FCH072N60F_F085 N-Channel Auto SuperFET, 600V, 52A, 72mohm

| Symbol | Parameter | | Ratings | Units | |
|-----------------------------------|--|------------------------|--------------|-------|--|
| V _{DSS} | Drain to Source Voltage | | 600 | V | |
| V _{GS} | Gate to Source Voltage | | ±20 | V | |
| ID | | T _C = 25°C | 52 | А | |
| | Drain Current - Continuous (V _{GS} =10) (Note 1 | T _C = 100°C | 33 | А | |
| | Pulsed Drain Current | | See Fig 4 | А | |
| E _{AS} | Single Pulse Avalanche Rating | (Note 2) | 1128 | mJ | |
| dv/dt | MOSFET dv/dt | | 100 | N//ma | |
| | Peak Diode Recovery dv/dt | (Note 3) | 50 | V/ns | |
| P _D | Power Dissipation | | 481 | W | |
| | Derate Above 25°C | | 3.85 | W/ºC | |
| T _J , T _{STG} | Operating and Storage Temperature | | -55 to + 150 | °C | |
| $R_{\theta JC}$ | Maximum Thermal Resistance Junction to Case | 0.26 | °C/W | | |
| $R_{\theta JA}$ | Maximum Thermal Resistance Junction to Ambie | 40 | °C/W | | |

Maximum Ratings $T_{C} = 25^{\circ}C$ unless otherwise noted

Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|-----------------|---------|-----------|------------|----------|
| FCH072N60F | FCH072N60F_F085 | TO-247 | - | - | 30 |

Notes:

1: Current is limited by bondwire configuration.

2: Starting $T_J = 25^{\circ}$ C, L = 25mH, $I_{AS} = 9.5$ A, $V_{DD} = 100$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.

3: $I_{SD} \le 26A$, di/dt ≤ 200 A/us, $V_{DD} \le 380V$, starting $T_J = 25^{\circ}C$.

4: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

| Symbol | Parameter | Test Conditions | | Min | Тур | Max | Units |
|---------------------|---|--|--|-----------|-------|------|-------|
| Off Cha | racteristics | | | | | | |
| B _{VDSS} | DSS Drain to Source Breakdown Voltage | | I _D = 250μA, V _{GS} = 0V | | - | - | V |
| | | $V_{DS} = 600V, T_J = 25^{\circ}C$ | | - | - | 10 | μA |
| IDSS | Drain to Source Leakage Current | | $T_{\rm J} = 150^{\rm o} {\rm C}({\rm Note}\ 5)$ | - | - | 1 | mA |
| I _{GSS} | Gate to Source Leakage Current | $V_{GS} = \pm 20V$ | | - | - | ±100 | nA |
| On Cha | racteristics | | | | | | |
| V _{GS(th)} | Gate to Source Threshold Voltage | V _{GS} = V _{DS} , I _D = 250µA | | 3.0 | 4.0 | 5.0 | V |
| · GS(III) | | I _D = 26A, | | - | 62 | 72 | mΩ |
| r _{DS(on)} | Drain to Source On Resistance | | $T_{\rm J} = 150^{\circ} C(\text{Note 5})$ | - | 154 | 195 | mΩ |
| Dynami | c Characteristics | | | 4 | -1 | | 1 |
| C _{iss} | Input Capacitance | — V _{DS} = 100V, V _{GS} = 0V, f = 1MHz | | _ | 6330 | - | pF |
| C _{oss} | Output Capacitance | | | - | 199 | - | pF |
| C _{rss} | Reverse Transfer Capacitance | | | - | 1.25 | - | pF |
| R _q | Gate Resistance | f = 1MHz | | - | 0.46 | - | Ω |
| Q _{g(ToT)} | Total Gate Charge | $V_{DD} = 380V$ $I_{D} = 26A$ $V_{GS} = 10V$ | | - | 160 | 210 | nC |
| Q _{g(th)} | Threshold Gate Charge | | | - | 11 | 16 | nC |
| Q _{gs} | Gate to Source Gate Charge | | | - | 34 | - | nC |
| Q _{gd} | Gate to Drain "Miller" Charge | | | - | 67 | - | nC |
| Switch | ing Characteristics | | | | | | |
| t _{on} | Turn-On Time | | | - | 75 | 100 | ns |
| t _{d(on)} | Turn-On Delay Time | | _ | - | 44 | - | ns |
| t _r | Rise Time | V_{DD} = 380V, I_D = 26A, V_{GS} = 10V, R_G = 4.7 Ω | | - | 31 | - | ns |
| t _{d(off)} | Turn-Off Delay Time | | | - | 128 | - | ns |
| t _f | Fall Time | | | - | 22 | - | ns |
| t _{off} | Turn-Off Time | | | - | 150 | 200 | ns |
| Drain-S | ource Diode Characteristics | | | | | | |
| V _{SD} | Source to Drain Diode Voltage | I _{SD} = 26A, V ₀ | I _{SD} = 26A, V _{GS} = 0V | | - | 1.2 | V |
| T _{rr} | Reverse Recovery Time | I _F = 26A, dI _{SD} /dt = 100A/μs V _{DD} = 480V | | - | 185 | - | ns |
| Q _{rr} | Reverse Recovery Charge | | | - | 1515 | - | nC |
| Note: 5: The max | imum value is specified by design at T _J = 150 |)°C. Product is no | t tested to this condition | in produc | tion. | | |

FCH072N60F_F085 N-Channel Auto SuperFET, 600V, 52A, 72mohm



FCH072N60F_F085 Rev. B2



FCH072N60F_F085 N-Channel Auto SuperFET, 600V, 52A, 72mohm



FCH072N60F_F085 Rev. B2



FCH072N60F_F085 Rev. B2





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